

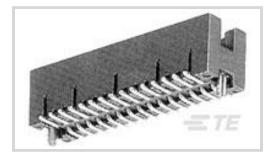
AMPMODU | AMPMODU 50/50 Grid

TE Internal #: 5-104655-7 PCB Mount Header, Vertical, Board-to-Board, 60 Position, 1.27 mm [.05 in] Centerline, Fully Shrouded, Gold, Surface Mount, Black, AMPMODU 50/50 Grid

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **60**

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Fully Shrouded

Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	60
Number of Rows	2
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	300 VAC
Operating Voltage	30 VAC
Body Features	
PCB Retention Feature Material	Copper Alloy
PCB Retention Feature Plating Material	Tin over Nickel
Connector Profile	Standard

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Primary Product Color	Black
Contact Features	
	150 µin
Mating Pin Diameter	.46 mm[.018 in]
Contact Shape & Form	Round
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Type	Pin
Contact Current Rating (Max)	.5 A
Termination Features	
Round Termination Post & Tail Diameter	.46 mm[.018 in]
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
PCB Mount Retention Type	Hold-Down Post
Mating Alignment	With
Mating Alignment Type	Keyed
PCB Mount Retention	With
Housing Features	
Centerline (Pitch)	1.27 mm[.05 in]
Housing Material	Thermoplastic
Dimensions	
Row-to-Row Spacing	1.27 mm[.05 in]
Stack Height	6.35 mm[.25 in]
Usage Conditions	
Operating Temperature Range	-65 – 105 °C
Industry Standards	
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	13

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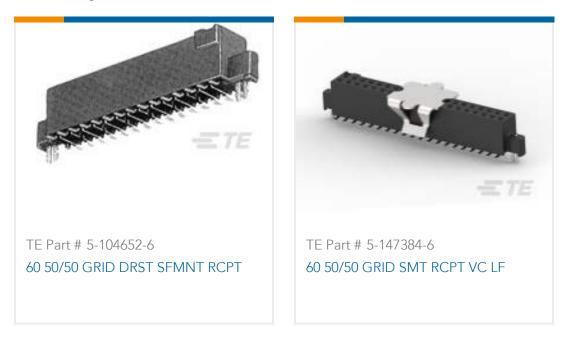


Packaging Type	Box, Tube
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series AMPMODU 50/50 Grid

PCB Mount Header, Vertical, Board-to-Board, 60 Position, 1.27 mm [.05 in] Centerline, Fully Shrouded, Gold, Surface Mount, Black, AMPMODU 50/50 Grid





Customers Also Bought



Documents

Product Drawings 60 50/50 HDR DRST SFMNT TIN

English

CAD Files

3D PDF

English

Customer View Model ENG_CVM_5-104655-7_L.2d_dxf.zip

English

Customer View Model

ENG_CVM_5-104655-7_L.3d_igs.zip

English

Customer View Model

ENG_CVM_5-104655-7_L.3d_stp.zip

English

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Datasheets & Catalog Pages AMPMODU_INTERCONNECTION_SYSTEM_SECTION1AND2

English

Ribbon Cable Interconnect Solutions

English

Fine Pitch Stacking Connectors - 1.27mm AMPMODU 50/50 Grid Connectors

English

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Product Specifications Application Specification

English

Agency Approvals

UL Report

English